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An In Situ Electrochemical Quartz Crystal Microbalance Study of the Dissolution Process of a Gold Electrode in Perchloric Acid Solution Containing Chloride Ion

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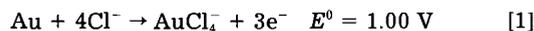
ABSTRACT

The anodic dissolution process of a Au(111) oriented electrode in HClO₄ solution containing various concentrations of chloride ion was investigated using an electrochemical quartz crystal microbalance (EQCM) under potential sweep and potentiostatic conditions. The in situ EQCM results clearly demonstrated that gold dissolves through a 3e⁻ oxidation process in the anodic potential region. No evidence for the 1e⁻ dissolution was obtained in the present study.

Introduction

Gold is known to have an excellent chemical stability. However, it becomes unstable and dissolves in the positive potential region,¹⁻³ especially in solutions containing chloride ion.⁴⁻¹⁴ This property is particularly important in the modern electronic industry for designing and manufacturing certain thin films and integrated circuits. Heumann and Panesar potentiostatically investigated the anodic behavior of a gold electrode in sulfuric acid solution containing chloride ion (Cl⁻) of various concentrations.⁴ They proposed that both the 1e⁻ and 3e⁻ oxidation reactions were involved in

the gold dissolution reaction in the anodic potential region as expressed by reactions 1 and 2, respectively



Gaur and Schmid studied the gold dissolution in the potential region of +1.0 ~ +1.2 V (vs. SCE) in 0.1 M HClO₄ containing 0.2–10 mM KCl.⁵ They suggested that gold dissolution and oxide formation are competitive reactions in the positive potential region and gold is dissolved as AuCl₄⁻ (reaction 1) only at an "oxygen-free" site on the gold electrode surface. Cadle and Bruckenstein investigat-

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ed the anodic behavior of the gold electrode in 0.2 M H₂SO₄ containing a trace amount of Cl⁻ by using a rotating ring-disk electrode and found that a cathodic current was observed at the ring electrode ($E_{\text{ring}} = 0$ V vs. SCE) as soon as the anodic current on the gold disk electrode started to flow around +1.1 V (vs. SCE).⁶ They proposed that the gold electrode was dissolved as Au(III) species (reaction 1). Frankenthal et al. reported that gold is dissolved as Au(I) (reaction 2) at less positive potentials (< +0.8 V vs. SCE) with a reaction order of Cl⁻ of 1.9 and as Au(III) (reaction 1) in a more positive potential region (< +1.1 V vs. SCE) with a diffusion-limited anodic current.^{7,8} Horikoshi et al. investigated the corrosion behavior of gold in 0.2 M H₂SO₄ solution containing Cl⁻ using coulometry and atomic absorption spectroscopy.⁹ They concluded that the 1e⁻ dissolution process (reaction 2) occurred at potentials more negative than +1.1 V (vs. SCE) and the 3e⁻ dissolution process (reaction 1) occurred at potentials more positive than +1.1 V. Lovrecek et al. studied the anodic dissolution and passivation behaviors of gold electrodes in neutral and acidic sulfate solutions, with and without Cl⁻, using a rotating disk electrode.¹⁰ They confirmed a diffusion-activation control of the dissolution process and suggested that AuCl₄⁻ was the final dissolution product. Diaz et al. investigated gold dissolution and deposition on a gold-deposited Pt rotating disk electrode in solutions with different Au(I)/Au(III) molar ratios, pH values, and Cl⁻ concentrations.¹¹ Based on the kinetics and thermodynamics analyses of the current-potential curves, they proposed that gold dissolved exclusively as AuCl₂⁻ at 0.8 V (vs. SCE) and as AuCl₄⁻ at more positive potentials. By using in situ surface-enhanced Raman spectroscopy (SERS) measurements, Loo found the formation of AuCl₂⁻ and AuCl₄⁻ species on a gold electrode surface in 0.1 M KCl solution in a potential region more negative and more positive than +0.9 V (vs. SCE), respectively.¹²

Recently, the dissolution process on a gold single-crystal surface in a solution containing trace amounts of Cl⁻ has been monitored by in situ scanning tunneling microscopy (STM).¹³⁻¹⁴ Terraces of the gold substrate in a Cl⁻-containing solution seem to be smoother than those in a Cl⁻-free solution after the formation and reduction of gold oxide. The faster surface diffusion rate of gold atoms in a Cl⁻-containing solution was proposed.^{13,14}

A number of issues concerning the anodic behavior of gold electrodes are still unclear. The quantitative analyses of product during the potentiostatic polarization measurements were usually carried out after a prolonged electrolysis because of the low sensitivity of the analysis techniques. This may cause a significant change in the surface state on the electrode and introduce larger errors in the quantitative analyses, especially in the case of a lower concentration of the product. Furthermore, since most of the studies were carried out on a polycrystalline gold electrode surface, it is impossible to discuss the mechanism of the dissolution process of the gold electrode on an atomic level.

In the present study, an electrochemical quartz crystal microbalance (EQCM) was employed to investigate the electrochemical dissolution process of a Au(111)-oriented electrode surface in perchloric acid (HClO₄) solution containing Cl⁻. EQCM can detect in situ mass changes at the electrode/electrolyte interface on a nanogram level with a time resolution of 1 s or better.¹⁵⁻¹⁸ It is clearly demonstrated that gold dissolves through a 3e⁻ oxidation process (reaction 1) over a very wide potential region. No evidence for the 1e⁻ dissolution process (reaction 2) was found in the present study.

Experimental

EQCM measurements were carried out at a Au(111)-oriented electrode prepared by vacuum evaporation of 3 nm titanium followed by 150 nm gold onto a 5 MHz AT-cut quartz crystal plate which was held at 300°C with an evaporation rate of ca. 0.5 nm/s. The formation of the highly ordered Au(111) phase with a long-range terrace-step structure by these procedures has been reported before.^{19,20}

and was confirmed by STM in this study. A gold bead electrode prepared by melting one end of a gold wire (0.8 mm diam) was also used for electrochemical characterization.²¹ A standard surface treatment procedure including annealing with a gas/O₂ flame and quenching in pure water was used to obtain reproducible surface states of the substrate. In order to investigate the gold dissolution process with the same surface state, only the first potential sweep was used for the EQCM measurement after the pretreatment.

Electrolyte solutions were prepared using Suprapure grade HClO₄ and NaCl (Wako Pure Chemicals) and Milli-Q water. The concentration of Cl⁻ was adjusted by adding 1.0 M NaCl stock solution into 0.1 M HClO₄ solution.

The electrode potential was controlled by a potentiostat (Hokuto Denko, HA-151) and external potential modulation was provided by a function generator (Hokuto Denko, HB-111). A quasi-reversible hydrogen electrode and a platinum wire (0.5 mm diam) were used as the reference and counter electrodes, respectively. All the potentials in this paper are presented with respect to the reversible hydrogen electrode (RHE).

The resonant frequency of the quartz crystal electrode, which was oscillated by a homemade oscillation circuit, was simultaneously monitored by a frequency counter (Hewlett Packard, HP53131A) controlled by a personal computer (NEC PC9821cb2) through a GPIB interface with respect to electrode potential and current. The frequency stability of the EQCM system was better than 0.1 Hz for a sampling gate time of 0.1 s. Details of the EQCM system used in this study were similar to those previously described.^{18,22} The mass change (Δm) was estimated from the resonant frequency change (Δf) using the Sauerbrey equation¹⁵⁻¹⁸

$$\Delta m = -k \times \Delta f \quad [3]$$

where k is the mass sensitivity of the 5 MHz AT-cut quartz crystal. The value of k was calibrated by the deposition reactions of silver and lead and was 19.3 ng/Hz cm².²²

All the measurements were carried out after the solution was deaerated by passing purified N₂ gas through the solution for at least 20 min.

Results and Discussion

Electrochemical characterization.—Figure 1 shows cyclic voltammograms (CVs) of a gold bead electrode obtained in 0.1 M HClO₄ solution with a Cl⁻ concentration of (a) 0, (b) 0.01, (c) 0.1, (d) 1, (e) 10, and (f) 100 mM in the potential region of 0 ~ +1.7 V.

A broad anodic wave with a peak at +1.32 V in the positive potential sweep and a cathodic peak at +1.17 V in the negative potential sweep, corresponding to the formation and reduction of oxide on the gold electrode surface, respectively, were observed in 0.1 M HClO₄ solution without Cl⁻ (Fig. 1a). An anodic peak with a small positive shift to +1.38 V was found in 0.1 M HClO₄ solution containing 0.01 mM Cl⁻ (Fig. 1b). The anodic peak was further shifted to +1.49 V with a larger peak current as the Cl⁻ concentration was increased to 0.1 mM (Fig. 1c). Cadle and Bruckenstein reported a similar positive shift of the anodic peak in 0.2 M H₂SO₄ solution containing a trace amount of Cl⁻.⁶ This peak shift should be related to the adsorption of Cl⁻ on the gold electrode surface which inhibits the formation of gold oxide in this potential region.^{6,23-26} No change was found in the cathodic peak at +1.17 V (Fig. 1a-c). As the Cl⁻ concentration became greater than 1 mM, the CVs drastically changed (Fig. 1d-f). The anodic peak around +1.4 V increased with the increase in Cl⁻ concentration. A second anodic peak or shoulder was observed around +1.5 V. The anodic current rapidly decreased as the potential became more positive. In addition to the cathodic peak at +1.17 V, which was attributed to the reduction of oxide on a gold surface, a new cathodic peak was observed around +1.0 V in the negative potential sweep. The higher the Cl⁻ concentration, the smaller the cathodic peak at +1.17 V and the larger the new cathodic peak. When the Cl⁻ concentration became higher than 100 mM, the cathodic peak at +1.17 V disappeared and an anodic peak was

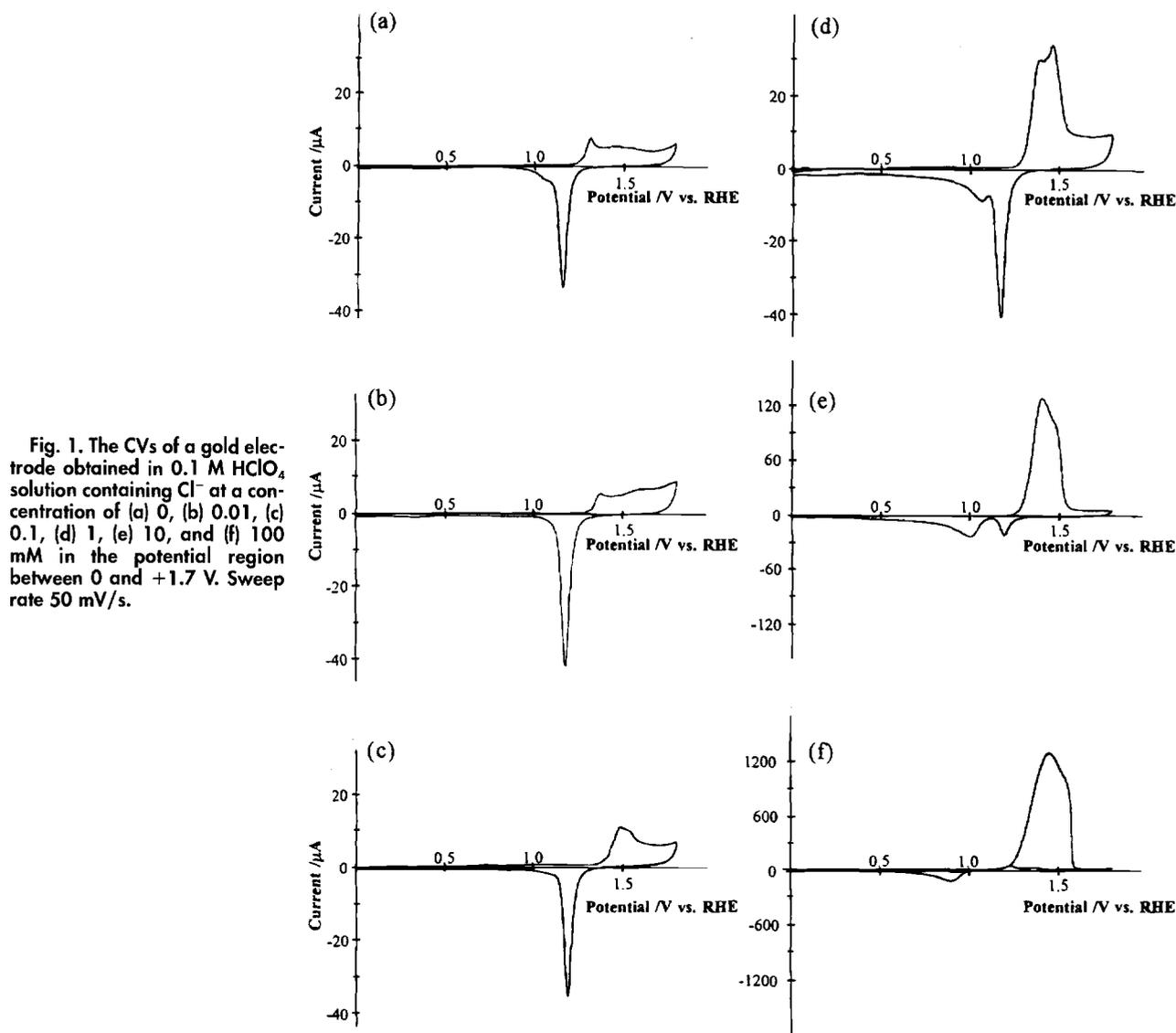


Fig. 1. The CVs of a gold electrode obtained in 0.1 M HClO₄ solution containing Cl⁻ at a concentration of (a) 0, (b) 0.01, (c) 0.1, (d) 1, (e) 10, and (f) 100 mM in the potential region between 0 and +1.7 V. Sweep rate 50 mV/s.

observed at +1.25 V (Fig. 1f), showing that an anodic reaction in addition to the reduction of surface oxide took place in this potential region.

Figure 2 shows the electric charges passed in the anodic and cathodic peaks as a function of the Cl⁻ concentration. Both the anodic and cathodic charges were almost constant

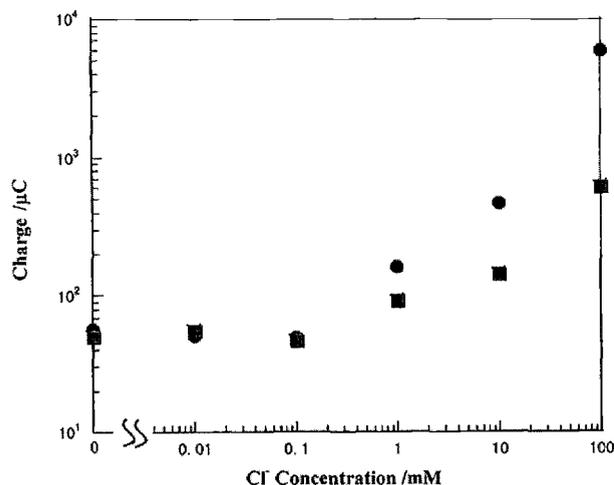
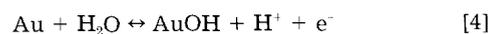
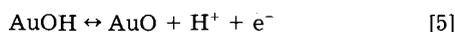


Fig. 2. The anodic (●) and cathodic (■) charges as a function of the Cl⁻ concentration obtained from the results shown in Fig. 1.

as long as the Cl⁻ concentration was lower than 0.1 mM but quickly increased as the Cl⁻ concentration became greater than 1 mM, suggesting new reactions, different from the oxide formation/reduction reactions, took place on the gold electrode. The cathodic charge was always smaller than the anodic charge for a given Cl⁻ concentration.

EQCM characterization with potential sweep in 0.1 M HClO₄ with Cl⁻.—Figure 3 shows the potential dependence of the current (—) and the mass change (---) in the potential region between +0.8 and +1.7 V in 0.1 M HClO₄ solution with (a) 0 and (b) 1 mM Cl⁻ at a gold electrode which was prepared on a 5 MHz AT-cut quartz crystal plate (sweep rate 50 mV/s). A sharp anodic peak at +1.58 V and a small peak at +1.40 V were observed. The shape of the CV is similar to those observed on the Au(111) electrode in HClO₄ solution,^{27,28} showing a well-defined Au(111) surface was exposed in the present experiment. The surface mass of the gold electrode started to increase as the anodic current started to flow and became constant at +1.7 V. A mass increase of ca. 30 ng was observed between +1.2 and +1.7 V in the positive potential sweep (Fig. 3a). In the negative potential sweep, the surface mass started to decrease as soon as the cathodic current started to flow at +1.2 V and returned to its initial value at +1.1 V. The reversible potential dependence of the current and the mass changes should be associated with the formation and reduction of gold oxide²⁷⁻³²





In 0.1 M HClO_4 solution containing 1 mM Cl^- (Fig. 3b), the surface mass of the gold electrode started to decrease as soon as the anodic current started to flow at +1.25 V. The mass decrease became small after the second anodic peak at +1.53 V and the surface mass became nearly constant around +1.6 V where the anodic current quickly decreased. The mass decreased by ca. 300 ng during the potential sweep from +0.8 to +1.7 V. In the negative potential sweep, the surface mass remained constant as long as the potential was more positive than +1.3 V where the cathodic current started to flow and started to decrease further with the appearance of the first cathodic peak at +1.2 V. The surface mass continued to decrease until +1.14 V where a current minimum between the first and the second anodic peaks was observed. The surface mass started to increase as the potential became more negative than this potential. The mass did not return to the original value at +0.8 V and a net mass loss of ca. 200 ng was observed after one potential cycle to +1.7 V. This behavior is very different from the result in Cl^- -free HClO_4 solution (Fig. 3a) where no net mass change was observed after a potential cycle. Thus, it is clear that gold was dissolved during a potential cycling in Cl^- -containing solution.

The CV shown in Fig. 3b can be divided into several regions based on the potential dependence of the current and the mass change, i.e., region I (< +1.25 V), II (+1.25 to +1.45 V), and III (+1.45 to +1.7 V) for the positive sweep, region IV (+1.7 to +1.3 V), V (+1.3 to +1.15 V), and VI (< +1.15 V) for the negative sweep. No anodic current flowed and no mass change was observed in region I. Regions II and III corresponded to the potential region of the first anodic peak at +1.4 V and the second peak at +1.53 V, respectively, in the positive potential sweep. The gold electrode is dissolved in region II and started to passivate in region III. Neither a current nor mass change was

observed in region IV. Regions V and VI included the first cathodic peak at +1.17 V and the second cathodic peak around +1.0 V, respectively, in the negative potential sweep. It should be mentioned here that this potential division (Fig. 3b) is only an approximate manner and changed with concentration of Cl^- and sweep rate. A more precise division can be achieved by a complete deconvolution of these peaks observed in the CV.

Sweep rate dependence.—Figure 4 shows the potential dependence of the current (—) and the mass change (---) in 0.1 M HClO_4 solution containing 1 mM Cl^- as the sweep rate was reduced to (a) 20, (b) 10, and (c) 5 mV/s. The currents were divided by the sweep rate (iv^{-1} , i.e., capacitance) for normalization. As the sweep rate became lower, anodic and cathodic peaks shifted slightly in the more negative and positive directions, respectively, and the relative height of the first anodic peak around +1.3 V became larger than that of the second one around +1.5 V. The lower the sweep rate, the larger the capacitance of both the anodic and cathodic peaks, and the larger the mass change.

Effect of positive potential limit.—Figure 5 shows the potential dependence of current (top) and the mass change (bottom) observed during a single potential cycle between +1.0 V and various positive potential limits in 0.1 M HClO_4 solution containing 1 mM Cl^- . No significant change of current and mass were observed in the potential sweep between +1.0 and +1.3 V (—). As the potential sweep was extended to +1.45 V in region II (○), a mass decrease corresponding to the anodic current in the CV was observed in the potential region between +1.35 and +1.45 V in the both positive and negative sweeps. This mass decrease is due to the gold dissolution as already described. Only one cathodic peak was found at +1.09 V (region VI) and the surface mass started to increase corresponding to this cathodic peak. When the positive potential limit was extended to +1.6 V in region III (●), the mass loss quickly decreased and the surface mass became nearly constant after the anodic peak at +1.53 V in the positive sweep. In the subsequent negative sweep, neither a current nor mass change was found until +1.32 V (region IV) and two cathodic peaks were observed in the more negative potential region, +1.22 V (region V) and +1.08 V (region VI), respectively. Since only the first cathodic peak around +1.22 V was observed in a Cl^- -free solution (Fig. 3a) and the second cathodic peak around +1.08 V became larger with the increase in Cl^- concentration in Cl^- -containing solution (Fig. 1), the cathodic peak at +1.08 V should be associated with the reduction process of the Au complexes that were produced during the dissolution that took place in region II and no surface oxide was formed in region II.

Effect of negative potential limit.—Figure 6 shows the potential dependence of current (top) and mass change (bottom) recorded during a single potential cycle between +1.7 V and various negative potential limits in 0.1 M HClO_4 solution containing 1 mM Cl^- . The gold electrode was in a passivated state at this potential before the potential scan with a negligible anodic current. When the potential was swept between +1.7 and +1.3 V, neither a current nor mass change was observed during both the negative and positive sweeps (—). When the potential became more negative than +1.3 V (region V), the surface mass started to decrease in the negative sweep corresponding to the flow of cathodic current (○). When the potential sweep was reversed to the positive direction, the mass continuously decreased corresponding to two anodic peaks in regions II and III (○). When the potential was swept into region VI (●), the surface mass, however, changed and increased as soon as the second cathodic peak started to flow from +1.15 V, suggesting that the dissolved gold species in solution was reduced on the electrode surface in the second cathodic peak at +1.08 V as already described. When the potential sweep was reversed to the positive direction at +1.0 V, the mass became constant until +1.3 V and then started to

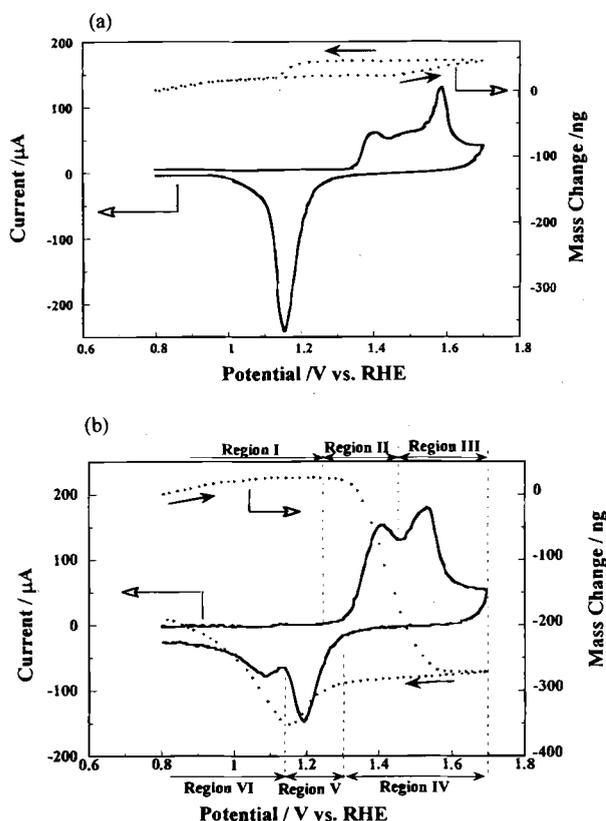


Fig. 3. The potential dependence of current (—) and mass changes (---) in the potential region between +0.8 and +1.7 V in 0.1 M HClO_4 solution containing (a) 0 and (b) 1 mM Cl^- . Scan rate 50 mV/s.

decrease again in regions II and III (●). The present results of the dependence of the negative potential limit (Fig. 6) are in good agreement with those of the dependence of the positive potential limit shown in Fig. 5.

Quantitative analysis.—Figure 7 shows the mass change on a gold electrode as a function of electric charge passed in Fig. 3b. The respective potential regions as described above are also shown in the same figure. The mass change per mole-equivalent electron (mpe) can be calculated from the slope of the curve. As mentioned in the Introduction, the $3e^-$ and $1e^-$ dissolution processes have been proposed for the dissolution process of a gold electrode in acidic solution containing Cl^- .⁴⁻¹² The mpe expected for the $3e^-$ (reaction 1) and $1e^-$ (reaction 2) processes are 65.7 and 197.0 g/mol-e, respectively. The potential-dependent mpe in the respective regions shown in Fig. 7 were calculated and discussed in detail as follows

Region I.—As shown in Fig. 3b and 5, a negligible anodic current and a small mass increase were observed in this potential region. This behavior should be associated with the adsorption of Cl^- and water molecules on the gold electrode surface which has been previously investigated by several methods, such as electroreflectance,²³ chronocoulometry,²⁴ EQCM,²⁵ and radiotracer.²⁶

Region II.—As shown in Fig. 7, a good linear relationship was found between the mass decrease and the anodic charge passed in this region. The slope of the straight line gives the mpe in this region as -66.7 g/mol-e. This value is in very good agreement with the one expected for the $3e^-$ dissolution (-65.7 g/mol-e), clearly demonstrating that the gold electrode dissolves through the $3e^-$ process (reaction 1) in this region.

Region III.—The straight line relation between the mass change and the anodic charge passed observed in region II

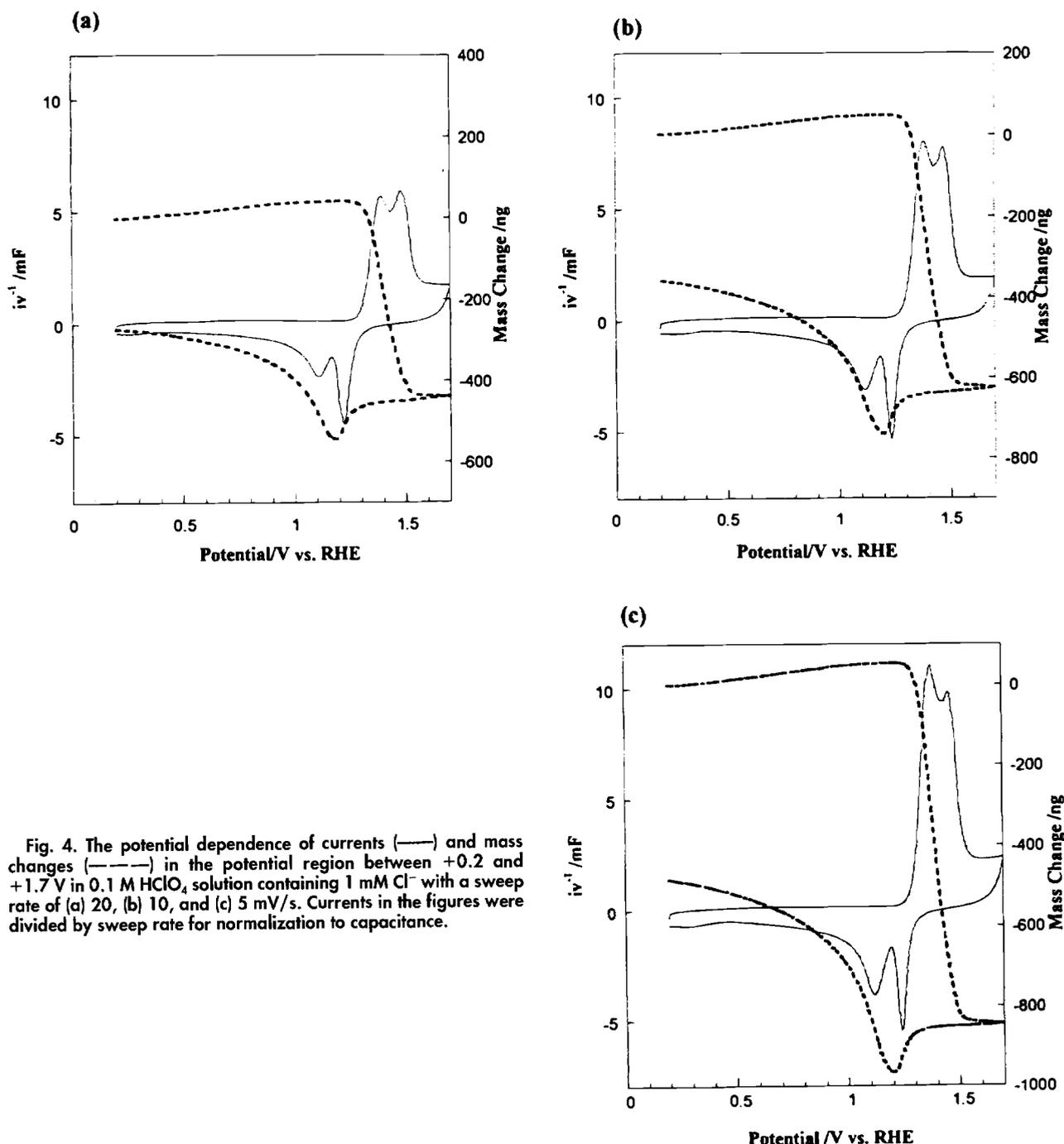


Fig. 4. The potential dependence of currents (—) and mass changes (---) in the potential region between +0.2 and +1.7 V in 0.1 M $HClO_4$ solution containing 1 mM Cl^- with a sweep rate of (a) 20, (b) 10, and (c) 5 mV/s. Currents in the figures were divided by sweep rate for normalization to capacitance.

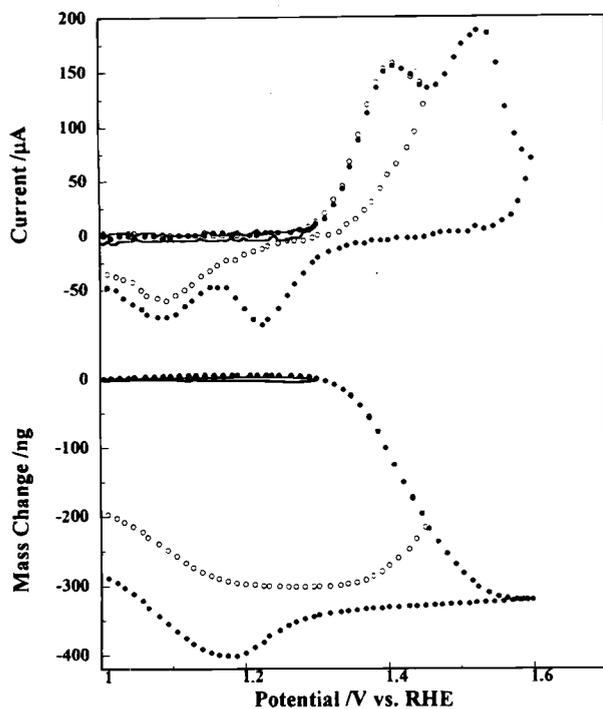


Fig. 5. The potential dependence of current (top) and mass change (bottom) observed during a single potential cycle between +1.0 V and various positive potential limits in 0.1 M HClO₄ solution containing 1 mM Cl⁻. Sweep rate 50 mV/s. See text for details.

became a curved line in region III. The tangent line of the curve became smaller as the potential became more positive and finally became nearly zero at the positive potential limit of region III, i.e., the mpe gradually decreased as the potential became positive, suggesting that the mpe is a mixing effect of at least two parallel reactions in the potential region.

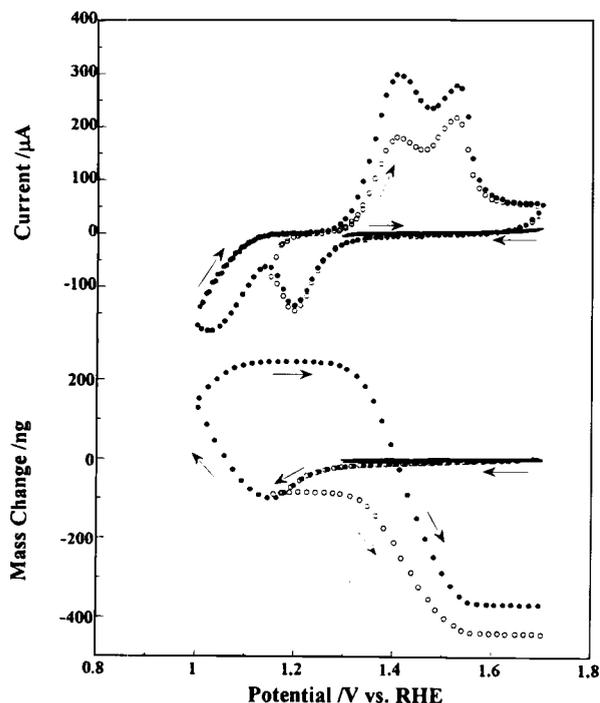


Fig. 6. The potential dependence of current (top) and mass change (bottom) observed during a single potential cycle between +1.7 V and various negative potential limits in 0.1 M HClO₄ solution containing 1 mM Cl⁻. Scan rate 50 mV/s. See text for details.

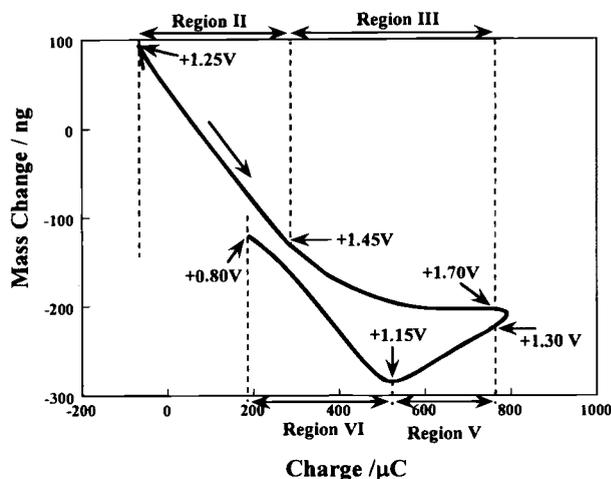


Fig. 7. The relationship between the mass changes and electric charge passed obtained from Fig. 3b. See text for the division of regions I, II, III, IV, V, and VI.

As described in Fig. 5 and 6, the formation of gold oxide took place in this potential region. The total mpe expected for the formation of gold oxide, AuOH and AuO, as shown by reactions 4 and 5, is +8.0 g/mol-e if additional water and anion adsorption on the oxide is ignored. In fact, the same mpe value of +8.0 g/mol-e for the oxide formation process was obtained in a Cl⁻-free solution (Fig. 3a). Thus, the decrease in the mpe in region III of Fig. 7 should be associated with the oxide formation reaction on the gold surface which gradually inhibits the gold dissolution process (Eq. 1, Eq. 2) and thus, a continuous decrease in the mpe was observed. In order to quantitatively discuss this process, it is necessary to separate the reactions of gold dissolution and oxide formation in this potential region. The total anodic charge (Q^{III}) observed in region III is represented as the sum of the anodic charge of the gold dissolution (Q_d^{III}) in the same potential region and that of oxide formation in monolayer (Q_0)

$$Q^{III} = Q_d^{III} + Q_0 \quad [6]$$

where Q_0 was determined from that of Cl⁻-free solution (Fig. 3a), i.e., $Q_0^{III} = 345 \mu\text{C}$. The Q^{III} was directly determined from the anodic charge in region III (Fig. 3b), i.e., $Q^{III} = 498 \mu\text{C}$. Based on Eq. 6, $Q_d^{III} = 153 \mu\text{C}$.

The mpe for the gold dissolution in region III can be calculated as follows

$$\text{mpe} = \frac{(\Delta m^{III} + \Delta m_0) \times S \times F}{Q_d^{III} \times 1000} \quad [7]$$

where Δm^{III} and Δm_0 are the mass changes (ng) observed in region III in 0.1 M HClO₄ with 1 mM Cl⁻ (Fig. 3b) and Cl⁻-free HClO₄ solution in the potential region between +1.1 and +1.7 V (Fig. 3a), respectively. $\Delta m^{III} = -156.3 \text{ ng}$ and $\Delta m_0 = +40.5 \text{ ng}$ were obtained from the respective figures. S is the electrode surface area, $S = 0.64 \text{ cm}^2$. F is the Faraday constant, $F = 96485 \text{ C/mol}$. The mpe for the gold dissolution in region III was -79.4 g/mol-e using Eq. 7. Considering possible overlapping between the reactions in regions II and III and calculation errors in integrating the anodic charge of the respective peaks, this mpe value is in agreement with that expected for the 3e⁻ dissolution process, -65.7 g/mol-e . It demonstrated that the gold surface was partly covered by oxide and is passivated completely when a full monolayer of oxide is formed on the gold surface.

Region IV.—As the potential sweep was reversed at +1.7 V in the negative direction, neither current nor mass change was observed until +1.3 V, suggesting that the gold electrode surface was passivated completely by the oxide formed in region III in the positive sweep (Fig. 3b and 5).

Region V.—As soon as the cathode current started to flow around +1.2 V, the surface mass started to decrease (Fig. 3b and 6). A fairly linear relation was obtained between the mass change and the cathodic charge passed with a positive slope from which the mpe was estimated as +29 g/mol-e. The mpe value was higher than that expected for the reduction process of the surface oxide (+8.0 g/mol-e). The cathodic charge of the cathodic peak in region IV ($Q_d^{IV} = -299 \mu\text{C}$, Fig. 3b) was smaller than that required for the reduction of surface oxide on a gold electrode in a Cl^- -free solution ($Q_r = -366 \mu\text{C}$, Fig. 3a). These results suggest that another anodic reaction should take place simultaneously with the reduction of gold oxide in this potential region. The anodic charge of the additional oxidation reaction (Q_d^{IV}) can be estimated using Eq. 8

$$Q^{IV} = Q_d^{IV} + Q_r \quad [8]$$

as $Q_d^{IV} = 67 \mu\text{C}$. Thus, the mpe for the new reaction can be calculated as follows

$$\text{mpe} = \frac{(\Delta m^{IV} + \Delta m_r) \times S \times F}{Q_d^{IV} \times 1000} \quad [9]$$

where Δm^{IV} and Δm_r are the mass change (ng) observed in 0.1 M HClO_4 with 1 mM Cl^- in region V (Fig. 3b) and in Cl^- -free HClO_4 solution between +1.7 and +1.0 V (Fig. 3a), respectively. As $\Delta m^{IV} = +110.0 \text{ ng}$ and $\Delta m_r = -48.2 \text{ ng}$, the mpe for the unknown reaction is calculated as -57.0 g/mol-e , which is in good agreement with that expected for the $3e^-$ dissolution process (-65.7 g/mol-e). Thus, the "additional anodic reaction" in region IV should be the gold dissolution reaction through a $3e^-$ mechanism (reaction 1) which took place as soon as the surface oxide was reduced.

Region VI.—The surface mass started to increase in region VI and a straight line with a negative slope was again obtained. The mpe was estimated as -61.8 g/mol-e . This value could be clearly explained as the result of a $3e^-$ rede-

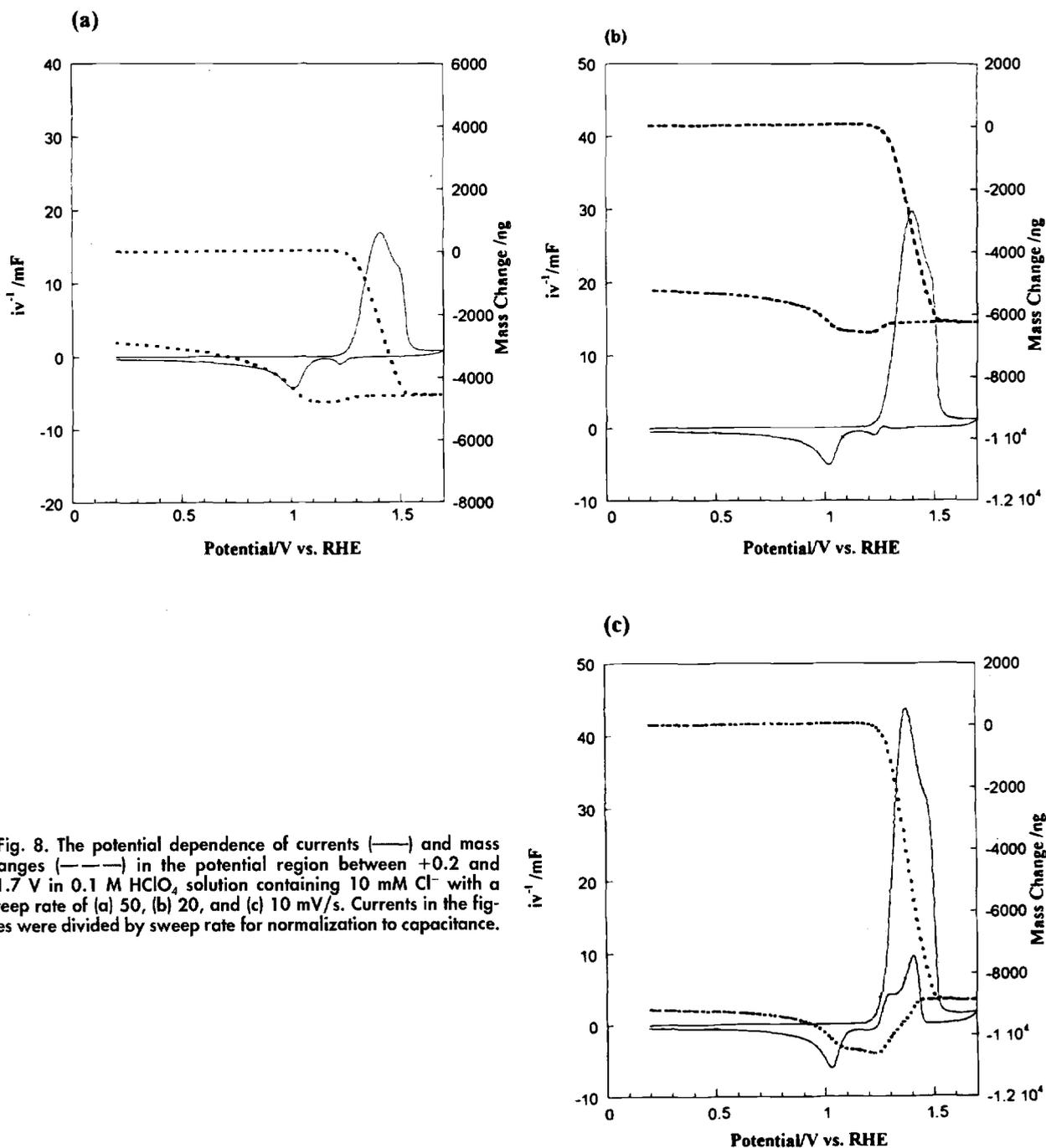


Fig. 8. The potential dependence of currents (—) and mass changes (---) in the potential region between +0.2 and +1.7 V in 0.1 M HClO_4 solution containing 10 mM Cl^- with a sweep rate of (a) 50, (b) 20, and (c) 10 mV/s. Currents in the figures were divided by sweep rate for normalization to capacitance.

position process of dissolved species AuCl_4^- (but not AuCl_2^-) to Au on the electrode surface, i.e., the reverse reaction of reaction 1. The redeposition reaction took place when the potential was more negative than +1.15 V.

Dependence of Cl^- concentration.—EQCM measurements were further carried out in 0.1 M HClO_4 solution with various concentrations of Cl^- . Figure 8 shows the potential dependence of the currents (—) and the mass changes in 0.1 M HClO_4 solution containing 10 mM Cl^- with a sweep rate of (a) 50, (b) 20, and (c) 10 mV/s. As described previously, the currents were divided by the sweep rate for normalization. The slower the sweep rate, the larger the capacitance and mass changes were observed. The anodic peak in region III was much larger than that observed in a solution containing 1 mM Cl^- as shown in Fig. 4 at a given sweep rate. A larger sweep rate dependence was observed, especially in region V in the negative potential sweep. When the sweep rate was high (50 mV/s), a small cathodic peak was observed at +1.22 V, which was very small compared to that of the second cathodic peak at +1.0 V (Fig. 8a). As the sweep rate was lowered to 20 mV/s, in addition to the small cathodic peak at +1.22 V, an anodic peak was observed at +1.27 V as a pair of bipolar redox peaks (Fig. 8b). Similar changes were also observed in the CV of 100 mM Cl^- solution with a higher sweep rate (50 mV/s, Fig. 1f). When the sweep rate was further reduced to 10 mV/s, a broad anodic peak was observed at +1.43 V with a shoulder at +1.3 V, and no cathodic peak was observed in this region (Fig. 8c). A large surface mass decrease was observed from +1.4 V, corresponding well to this anodic current flow (Fig. 8c). Since the potential for this anodic peak was more positive than that for the reduction of gold oxide in Cl^- -free solution (Fig. 3a), the gold oxide seems to be unstable and can be partly destroyed by a concentrated Cl^- solution, especially under the condition of lower sweep rate. The second cathodic peak around +1.08 V in region VI, however, did not change much with the sweep rate. These results confirmed the conclusion described previously (Fig. 7), i.e., dissolution of gold took place as soon as the gold oxide formed in region III was reduced.

Quantitative analyses described in the previous section were employed for the 0.1 M HClO_4 with various concentrations of Cl^- . Although the CVs and the mass changes depended on the Cl^- concentration, similar potential regions as already described were used for these solutions. Table I summarizes the mpe values as a function of the Cl^- concentration in the respective potential regions. The potential limits for the respective regions are given in the same table.

As shown in Table I, the mpe values in regions II and VI in the solutions with different concentrations of Cl^- were found to be between -50 and -70 g/mol-e. As discussed in the case of the 0.1 M HClO_4 solution with 1 mM Cl^- , the processes in region II and region VI corresponded to the $3e^-$ dissolution and $3e^-$ redeposition processes on the gold electrode, respectively. Considering a possible incomplete separation of respective regions and calculation errors in integrating the respective peak areas, it is fair to say that these values were in good agreement with the mpe values

(-65.7 g/mol-e) expected for the $3e^-$ dissolution of gold (reaction 1) or $3e^-$ redeposition of AuCl_4^- species (reverse reaction of reaction 1).

No evidence was found in the EQCM measurements for the $1e^-$ redeposition (reaction 2) for which the mpe is expected to be -197 g/mol-e.

The mpe values of regions III and V (Table I) were obtained after subtracting the effects of oxide formation or reduction reactions on a gold electrode surface by using the same procedures described in the previous section. Again, these values are close to the mpe value expected for the $3e^-$ dissolution process (reaction 1), i.e., the formation of gold oxide was started in region III as a competition reaction for gold dissolution, and the dissolution was completely inhibited when a full monolayer oxide was formed on the gold electrode surface in region IV.

EQCM characterization with potentiostatic measurement.—The current and the mass change during the gold dissolution process were further investigated using the potentiostatic measurements.

Figure 9a shows a typical result for the potentiostatic measurement in which the current and the mass change were recorded simultaneously as a function of time in 0.1 M HClO_4 solution containing 5 mM Cl^- when the potential was stepped from +1.0 to +1.3 V in region II where the gold was dissolved. A large anodic current spike due to the charging of the double layer flowed immediately after the potential step, after which the anodic current quickly decreased and reached a steady current of 5 μA . The surface mass started to decrease as soon as potential was stepped to +1.3 V. A good linear relationship was obtained between the mass decrease and the anodic charge passed (Fig. 9b). The mpe was calculated from the slope of the straight line as -64.7 g/mol-e. This value is in good agreement with the value expected for the $3e^-$ gold dissolution process (-65.7 g/mol-e, reaction 1), confirming that a $3e^-$ dissolution process for the gold electrode took place under the present potentiostatic conditions.

Figure 10 summarizes the potential dependence of the anodic current (Fig. 10a) and the mpe (Fig. 10b) obtained by the potentiostatic measurements in 0.1 M HClO_4 solution containing 5 mM Cl^- . In Fig. 10a, a linear relationship was observed between +1.2 and +1.3 V and the Tafel slope of the straight line was ca. 0.054 V, which is the same as those reported previously.^{4,8,9,11} The anodic current was found to be independent of the potential in the more positive potential region between +1.35 and +1.50 V. It is evident that this is associated with the diffusion-controlled dissolution process which has been well studied by rotating disk electrode.^{5,8,9,11} As the potential entered region III, the steady anodic current started to decrease. This should be attributed to the formation of oxide on the gold electrode surface as previously mentioned.

Figure 10b shows the potential dependence of the mpe determined by the potentiostatic measurement in regions II and III. In region II, the mpe was nearly constant and was close to the value of -65.7 g/mol-e (indicated by the dotted line) which is expected for the $3e^-$ dissolution process of the gold electrode. As the potential became more positive than

Table I. Cl^- concentration dependence of the mpe observed in regions II, III, V, and VI.

Concentration (mM)	mpe (g/mol-e) in region II	mpe (g/mol-e) in region III	mpe (g/mol-e) in region V	mpe (g/mol-e) in region VI
0.1	-59.8 (1.33-1.45 V)	-78.2 (1.45-1.70 V)	-55.2 (1.30-1.16 V)	-48.4 (1.16 V~)
1	-66.7 (1.25-1.45 V)	-79.4 (1.45-1.70 V)	-57.0 (1.30-1.15 V)	-61.8 (1.15 V~)
2	-65.0 (1.25-1.47 V)	-60.4 (1.47-1.70 V)	-62.6 (1.30-1.14 V)	-66.6 (1.14 V~)
5	-61.8 (1.25-1.49 V)	-64.8 (1.49-1.70 V)	-68.3 (1.40-1.14 V)	-66.5 (1.14 V~)
10	-58.9 (1.22-1.51 V)	-51.6 (1.51-1.70 V)	-66.8 (1.40-1.15 V)	-64.2 (1.15 V~)

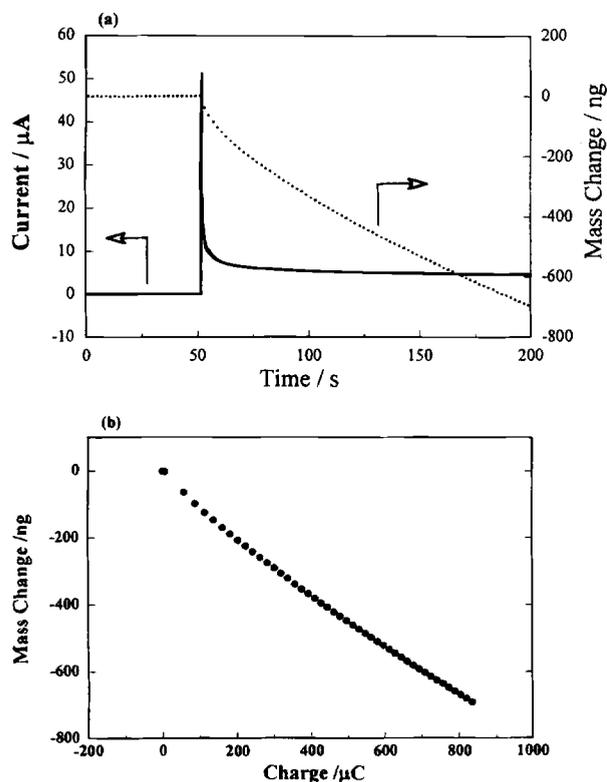


Fig. 9. (a) The time dependence of the current and the mass change simultaneously recorded as the potential was stepped from +1.0 to +1.3 V. (b) The relationship between the mass change and the anodic charge as the potential was stepped from +1.0 to +1.3 V in 0.1 M HClO_4 solution containing 5 mM Cl^- .

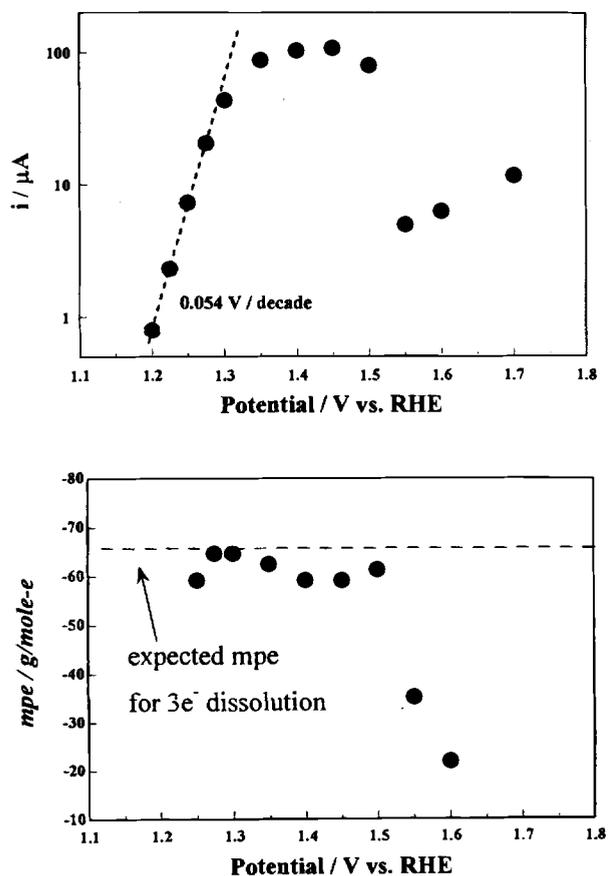


Fig. 10. The potential dependence of (a, top) anodic current and (b, bottom) mpe obtained by the potentiostatic polarization measurements in 0.1 M HClO_4 solution containing 5 mM Cl^- .

+1.5 V (region III), the observed mpe started to decrease. The mpe was found to be ca. -20 g/mol-e at +1.6 V. As discussed in the case of the potential sweep in the same potential region, this decrease should be related to the formation of a surface oxide which inhibits further gold dissolution.

In both the potential sweep and potentiostatic measurements, only the $3e^-$ dissolution/redeposition was observed. This conclusion is different from those reported before in which a $1e^-$ dissolution process was also found.^{4,7-9,11} Many reasons are considered in order to explain this difference. One of the important reasons is the different sensitivity and accuracy between the present EQCM measurement and experimental methods used in the previous studies. In the previous studies, usually a long electrolysis time was necessary to obtain enough sensitivity in the subsequent product analyses. A significant change in the surface state on the gold electrode may take place and large errors in the quantitative analyses may be introduced during prolonged electrolysis. The in situ EQCM measurement should be much more reliable as it can detect the absolute mass change with the highest mass precision (several percent of a monolayer) and a very short electrolysis time (less than a few seconds) is required.

Cl^- concentration-dependent potential region for dissolution and passivation.—Figure 11 summarizes the Cl^- concentration (0.1–10 mM) dependent potential regions in which the potential boundaries between regions I, II, and III were obtained by EQCM measurement with potential sweep. Since the concentration of AuCl_4^- was unknown in the present experiment, the equilibrium potential of $\text{AuCl}_4^-/\text{Au}$ was estimated as a function of the Cl^- concentrations by the Nernst equation for AuCl_4^- concentrations from 0.001 to 10 mM (Fig. 12). However, the calculated equilibrium potentials were more negative than the onset potentials observed even for the case of 2.5 mM AuCl_4^- -containing solution, which is the highest available AuCl_4^- concentration for the solution containing 10 mM Cl^- . This difference between the experimentally observed onset potential and the calculated equilibrium potential should be caused by the adsorption of Cl^- on the Au(111) electrode.^{6,23-26}

As shown in Fig. 11, the gold electrode started to dissolve at a less positive potential when the Cl^- concentration increased. The equilibrium potential for the $3e^-$ dissolution reaction of the gold electrode (reaction 1) is expected to linearly decrease with the logarithmic concentration of Cl^- with a slope of $-(0.060/3) \times 4 = -0.080$ V/dec from the Nernst equation if the concentration of AuCl_4^- is constant. It was found from Fig. 12 that the onset potential for gold dissolution linearly shifted to a negative direction with the logarithmic concentration of Cl^- with a slope of ca. -0.054 V/dec, lower than the expected one (-0.080 V/dec). This may also be related to the specific adsorption of Cl^- on the Au(111) electrode.

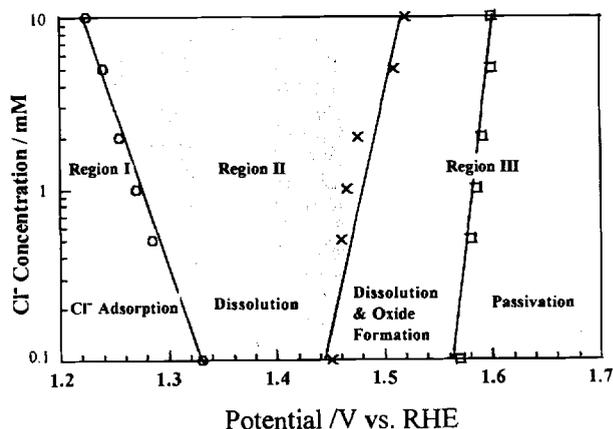


Fig. 11. Cl^- concentration-dependent potential region in positive-going sweep in 0.1 M HClO_4 solution containing Cl^- .

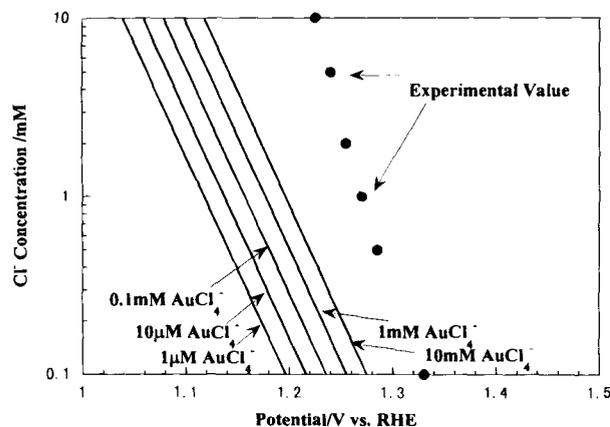


Fig. 12. The equilibrium potential of $\text{AuCl}_4^-/\text{Au}$ estimated by Nernst equation as a function of the Cl^- concentration for concentrations of AuCl_4^- from $1 \mu\text{M}$ to 10mM , shown by the arrows in the figure.

The onset potential for the oxide formation depended on the Cl^- concentration. The higher the Cl^- concentration, the more positive the onset potential. A similar tendency was found for the onset potential of the passive region. This passive oxide layer, however, is unstable and is partly destroyed in a concentrated Cl^- -containing HClO_4 solution.

An in situ EC-STM study is now underway to investigate in detail the dissolution and redeposition processes on an Au(111) electrode surface.

Conclusion

The dissolution process of the gold electrode in HClO_4 solution containing various concentrations of Cl^- was investigated by in situ EQCM measurements. The EQCM results clearly demonstrate that gold dissolves through a $3e^-$ oxidation process in the anodic potential region. No evidence for the $1e^-$ dissolution was obtained in the present study.

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